

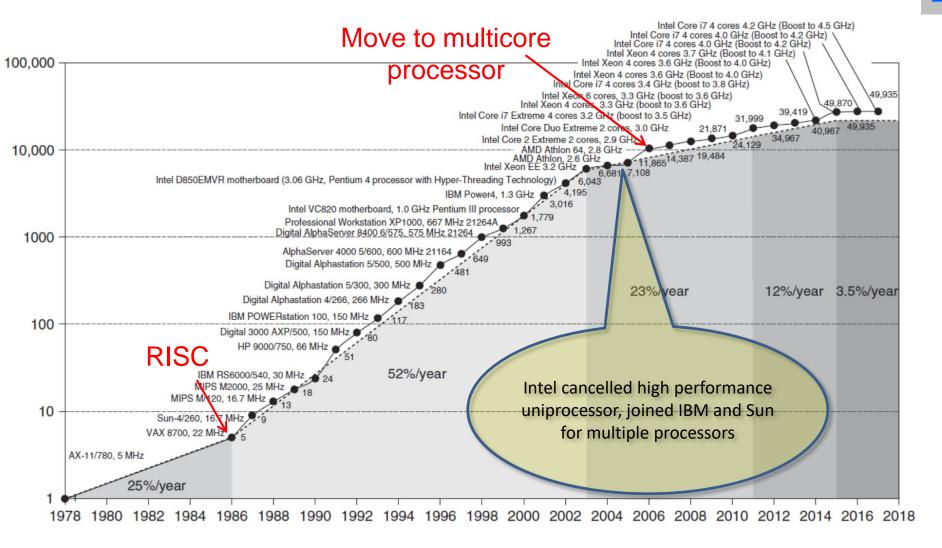
Computer Architecture Lecture 1: Fundamentals of Quantitative Design and Analysis (Chapter 1)

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Single Processor Performance





Computer Technology

- Performance improvements:
 - Improvements in semiconductor technology
 - Feature size, clock speed
 - Improvements in computer architectures
 - Enabled by high-level language (HLL) compilers, UNIX
 - Lead to RISC architectures
 - Together have enabled:
 - Lightweight computers
 - Productivity-based managed/interpreted programming languages



Current Trends in Architecture

- Cannot continue to leverage Instruction-Level parallelism (ILP)
 - Single processor performance improvement ended in 2003
- New models for performance:
 - Data-level parallelism (DLP)
 - Thread-level parallelism (TLP)
 - Request-level parallelism (RLP)
- These require explicit restructuring of the application



Classes of Computers

- Clusters / Warehouse Scale Computers
 - Used for "Software as a Service (SaaS)." Emphasis on availability and price-performance.
 - Supercomputers. Emphasis on floating-point performance and fast internal networks
- Servers
 - Emphasis on availability, scalability, and efficient throughput
- Desktop Computing
 - Emphasis on price-performance index
- Personal Mobile Device (PMD)
 - Emphasis on energy efficiency and real-time constraints
- Internet of Things/Embedded Computers
 - Have the widest spread of processing power and cost.
 - Emphasis on cost-price index (meets the performance need at a minimum price, rather than achieving more performance at a higher price.)



Parallelism

- Classes of parallelism in applications:
 - Data-Level Parallelism (DLP)
 - Task-Level Parallelism (TLP)
- Classes of architectural parallelism:
 - Instruction-Level Parallelism (ILP)
 - Vector architectures/Graphic Processor Units (GPUs)
 - Thread-Level Parallelism
 - Request-Level Parallelism



Flynn's Taxonomy

- Single instruction stream, single data stream (SISD)
- Single instruction stream, multiple data streams (SIMD)
 - Vector architectures
 - Multimedia extensions
 - Graphics processor units
- Multiple instruction streams, single data stream (MISD)
 - No commercial implementation
- Multiple instruction streams, multiple data streams (MIMD)
 - Tightly-coupled MIMD
 - Loosely-coupled MIMD

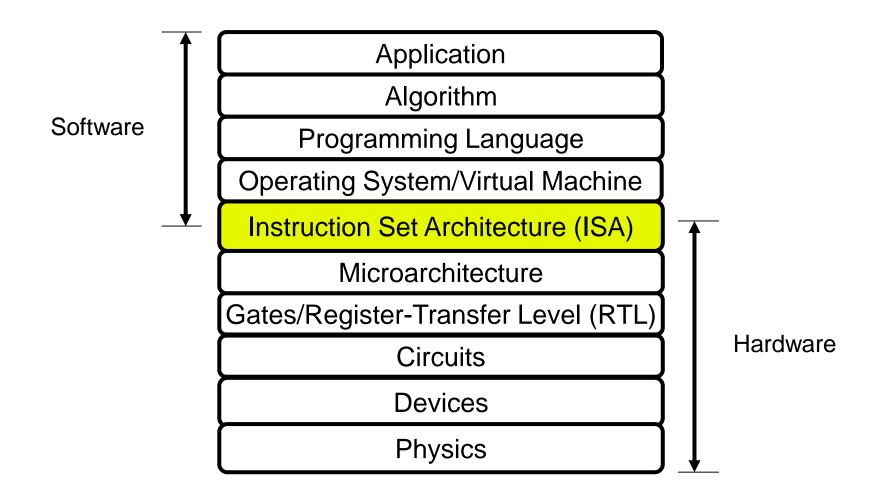


Defining Computer Architecture

- "Old" view of computer architecture:
 - Instruction Set Architecture (ISA) design
 - i.e. decisions regarding:
 - registers, memory addressing, addressing modes, instruction operands, available operations, control flow instructions, instruction encoding
- "Real" computer architecture:
 - Specific requirements of the target machine
 - Design to maximize performance within constraints: cost, power, and availability
 - Includes ISA, microarchitecture, hardware



Computer System vs. ISA





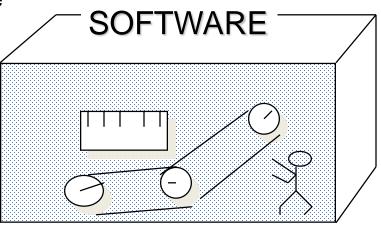
Instruction Set Architecture, ISA

"... the attributes of a [computing] system as seen by the programmer, *i.e.* the conceptual structure and functional behavior, as distinct from the organization of the data flows and controls the logic design, and the physical implementation."

— Amdahl, Blaauw, and Brooks, 1964

Organization of Programmable Storage

- Data Types & Data Structures:Encodings & Representations
- Instruction Formats
- Instruction (or Operation Code) Set
- Modes of Addressing and Accessing Data Items and Instructions
- Exceptional Conditions





ISA Design Issue

- Where are operands stored?
- How many explicit operands are there?
- How is the operand location specified?
- What type & size of operands are supported?
- What operations are supported?



Before answering these questions, let's consider more about

- Memory addressing
- Data operand
- Operations



Class of ISA

- RISC vs. CISC (code density issue)
- Almost all ISAs today are classified as general-purpose register (GPR) architectures
 - The operands are either registers or memory locations
 - Register-memory ISAs
 - Part of instructions can access memory, i.e. one of the operands can be memory location
 - E.g., 80x86
 - Load-store ISA
 - Only load and store instructions can access memory
 - All ISAS announced since 1985 are load-store. E.g., MIPS, ARM, RISC-V



RISC-V Registers

- 32 general-purpose registers and 32 floating-point registers
 - Name, usage, and calling conventions

				Register	Name	Use	Saver
				x9	s1	saved	callee
Register	Name	Use	Saver	x10-x17	a0-a7	arguments	caller
х0	zero	constant 0	n/a	x18-x27	s2-s11	saved	callee
x1	ra	return addr	caller	x28-x31	t3-t6	temporaries	caller
x2	sp	stack ptr	callee	f0-f7	ft0-ft7	FP temps	caller
х3	gp	gbl ptr		f8-f9	fs0-fs1	FP saved	callee
x4	tp	thread ptr		f10-f17	fa0-fa7	FP arguments	callee
x5-x7	t0-t2	temporaries	caller				
x8	s0/fp	saved/	callee	f18-f27	fs2-fs21	FP saved	callee
	, ,	frame ptr		f28-f31	ft8-ft11	FP temps	caller

The registers that are preserved across a procedure call are labeled "Callee" saved.



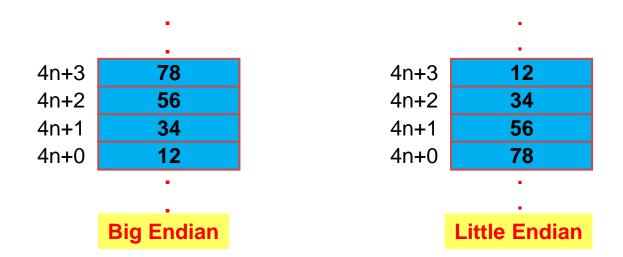
Memory Addressing

- Most CPUs are byte-addressable and provide access for
 - Byte (8-bit)
 - Half word (16-bit)
 - Word (32-bit)
 - Double words (64-bit)
- How memory addresses are interpreted and how they are specified?
 - Little Endian or Big Endian
 - for ordering the bytes within a larger object within memory
 - Alignment or misaligned memory access
 - for accessing to an abject larger than a byte from memory
 - Addressing modes
 - for specifying constants, registers, and locations in memory



Little or Big Endian?

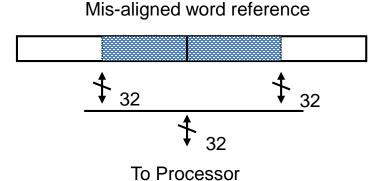
- No absolute advantage for one over the other, but
 Byte order is a problem when exchanging data among computers
- Example
 - $\ln C$, int num = 0x12345678; // a 32-bit word,
 - how is num stored in memory?





Alignment Data Access

- The memory is typically aligned on a word or double-word boundary.
- An access to object of size S bytes at byte address A is called aligned if $A \mod S = 0$.
- Access to an unaligned operand may require more memory accesses!!





Remarks

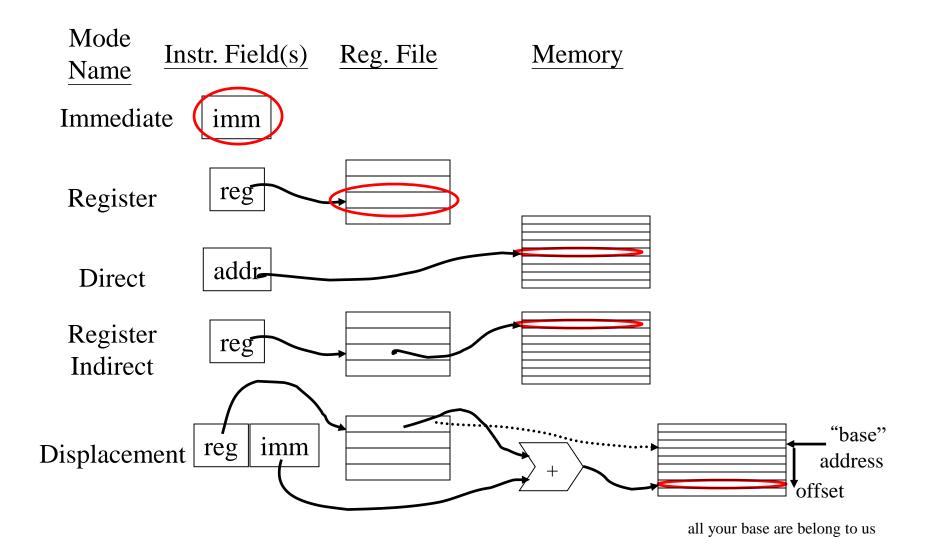
- ARM requires alignment access, while 80x86 and RISC-V do not require alignment.
- Unrestricted Alignment
 - Software is simple
 - Hardware must detect misalignment and make more memory accesses
 - Expensive logic to perform detection
 - Can slow down all references
 - Sometimes required for backwards compatibility
- Restricted Alignment
 - Software must guarantee alignment
 - Hardware detects misalignment access and traps
 - No extra time is spent when data is aligned
- Since we want to make the common case fast, having restricted alignment is often a better choice, unless compatibility is an issue.



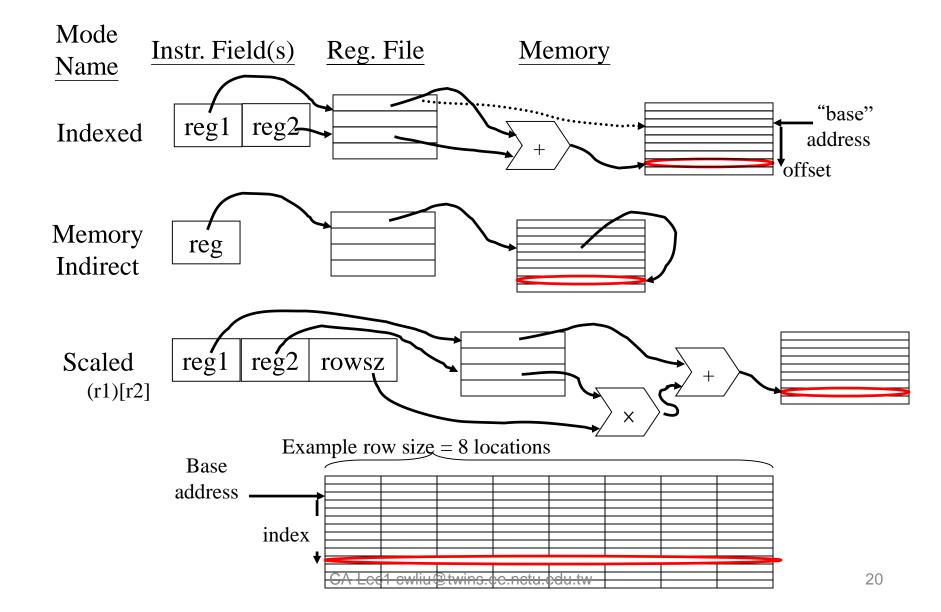
Addressing Mode?

- It answers the question:
 - Where can operands/results be located?
- Address modes are used to specify registers and the address of a memory object
- Recall that we have two types of storage in computer : registers and memory
 - A single operand can come from either a register or a memory location
 - Addressing modes offer various ways of specifying the specific location

Addressing Modes Visualization (1)



Addressing Modes Visualization (2)





Addressing Mode Example

Addressing Mode	Example	Action		
1. Register direct	Add R1, R2, R3	R1 <- R2 + R3		
2. Immediate	Add R1, R2, #3	R1 <- R2 + 3		
3. Register indirect	Add R1, R2, (R3)	R1 < - R2 + M[R3]		
4. Displacement	LD R1, 100(R2)	$R1 \leftarrow M[100 + R2]$		
5. Indexed	LD R1, (R2 + R3)	$R1 \leftarrow M[R2 + R3]$		
6. Direct	LD R1, (1000)	R1 <- M[1000]		
7. Memory Indirect	Add R1, R2, @(R3)	$R1 \leftarrow R2 + M[M[R3]]$		
8. Auto-increment	LD R1, (R2)+	R1 <- M[R2]		
		R2 <- R2 + d		
9. Auto-decrement	LD R1, (R2)-	R1 <- M[R2]		
		R2 <- R2 - d		
10. Scaled	LD R1, 100(R2)[R3]	R1 <- M[100+R2+R3*d]		

R: Register, M: Memory



How Many Addressing Mode?

- A Tradeoff: complexity vs. instruction count
 - Should we add more modes?
 - Depends on the application class
 - Special addressing modes for DSP/GPU processors
 - Modulo or circular addressing
 - Bit reverse addressing
 - Stride, gather/scatter addressing
 - DSPs sometimes rely on hand-coded libraries to exercise novel addressing modes
- Need to support at least three types of addressing mode
 - Displacement, immediate, and register
 - A typical 12-bit displacement field
 - A typical of 12-bit immediate field



Type and Sizes of Operands

- 8-bit operand
 - Byte data, ASCII character
- 16-bit operand
 - Half-word data, Unicode character
- 32-bit operand
 - Integer or Word, IEEE 754 floating-point (FP) single precision
- 64-bit operand
 - Long integer or Double word, IEEE 754 FP double precision



Operations/Instructions in RISC

- RISC is a simple and easy-to-pipeline ISA
- Data transfers
 - Move data between registers and memory, or between integer and FP/special registers
- Arithmetic/logical
 - Operations on integer or logical data in GPRs
- Program flow control
 - Conditional branches
 - Unconditional jumps
 - Procedure call and return
 - MIPS, ARM, and RISC-V place the return address in a register (RA), while 80x86 place the return address in a stack in memory
- Predicated instructions
 - Whether the result of an arithmetic/logic operation is saved or ignored is depending on the condition code bits (e.g., ARM)



Procedure Calling

Caller

- Steps required
 - 1. Place parameters in registers
 - 2. Transfer control to procedure
 - 3. Acquire storage for procedure
 - 4. Perform procedure's operations
 - 5. Place result in register for caller
 - 6. Return to place of call

Note that you have only one set of registers !!

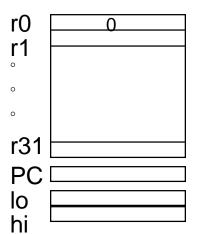


Predicated/Conditional Instructions

- ARM uses (N, Z,C, O) condition codes for result of an arithmetic/logical instruction
 - Top 4 bits of instruction word stores 4 condition value : Negative, Zero, Carry, Overflow
 - Compare instructions are used to set condition codes without keeping the result
- Almost all instructions can be conditional
 - Can avoid branches over single instructions



Example: MIPS



Programmable storage

2^32 x bytes

31 x 32-bit GPRs (R0=0)

32 x 32-bit FP regs (paired DP)

HI, LO, PC

Data types?

Format?

Addressing Modes?

Arithmetic logical

Add, AddU, Sub, SubU, And, Or, Xor, Nor, SLT, SLTU,

Addl, AddlU, SLTI, SLTIU, Andl, Orl, Xorl, LUI

SLL, SRL, SRA, SLLV, SRLV, SRAV

Memory Access

LB, LBU, LH, LHU, LW, LWL, LWR

SB, SH, SW, SWL, SWR

Control

J, JAL, JR, JALR

BEq, BNE, BLEZ, BGTZ, BLTZ, BGEZ, BLTZAL, BGEZAL

32-bit instructions on word boundary



Encoding an ISA

- Fixed-length vs. Variable-length encoding
 - Code size issue
 - MIPS, ARMv8, and RISC-V are 32-bit fixed-length encoding
 - 80x86 is a variable-length (1~18 bytes) encoding
- Compressed encoding
 - For embedded system with a small on-chip memory
 - ARM 16-bit Thumb encoding

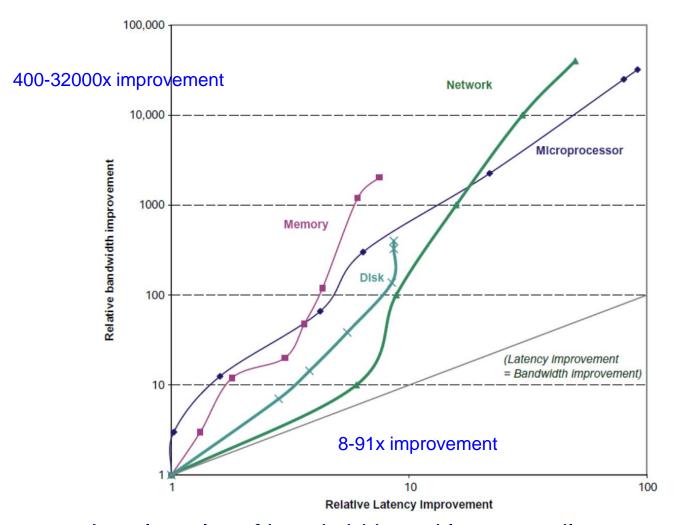


Trends in Technology

- Integrated circuit technology: doubling every 18-24 months
 - Transistor density: 35%/year
 - Die size: 10-20%/year
 - Integration overall: 40-55%/year
- DRAM capacity: 25-40%/year (slowing)
 - 8 Gb (2014), 16 Gb (2019), possibly no 32 Gb
- Flash capacity: 50-60%/year
 - 8-10X cheaper/bit than DRAM
- Magnetic disk technology: recently slowed to 5%/year
 - Density increases may no longer be possible, maybe increase from 7 to 9 platters
 - 8-10X cheaper/bit then Flash
 - 200-300X cheaper/bit than DRAM
- Network technology:



Bandwidth and Latency



Log-log plot of bandwidth and latency milestones



Bandwidth and Latency

- Bandwidth or throughput
 - Total work done in a given time
 - 32,000-40,000X improvement for processors
 - 300-1200X improvement for memory and disks
- Latency or response time
 - Time between start and completion of an event
 - 50-90X improvement for processors
 - 6-8X improvement for memory and disks



Transistors and Wires

- Feature size
 - Minimum size of transistor or wire in x or y dimension
 - 10 microns in 1971 to .011 microns in 2017
 - Transistor performance scales linearly
 - Wire delay does not improve with feature size! Because the resistance and capacitance per unit length get worse.
 - Integration density scales quadratically
- As feature sizes shrink, devices shrink quadratically both in the horizontal dimension and in the vertical dimension



Why Bandwidth Over Latency?

- Moore's law helps BW more than latency
 - Faster transistors, more transistors, and more pin count help bandwidth
 - Smaller transistors communicate over (relatively) longer wires
- Latency helps BW, but not vice versa
 - Lower DRAM latency, i.e. more accesses per second, implies higher bandwidth
 - Higher density of disk helps BW and capacity, but not disk latency
- BW hurts latency
 - Queues or buffers help bandwidth, but hurt latency
 - Memory bank help bandwidth with widen the memory module, but not latency due to higher fan-out on address lines
- OS overhead hurts latency more than BW
 - Packet header overhead: bigger part of short message



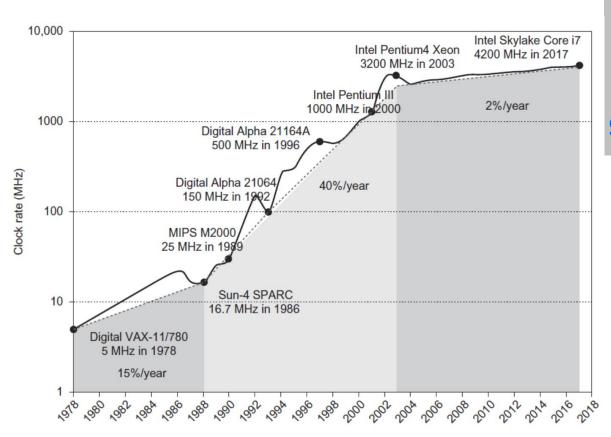
Summary of Technology Trends

- A simple rule of thumb: bandwidth improves by at least the square of the improvement in latency.
 - In the time that bandwidth doubles, latency improves by no more than 1.2X to 1.4X
- Lag probably even larger in real systems, as bandwidth gains multiplied by replicated components
 - Multiple processors in a cluster or even in a chip
 - Multiple disks in a disk array
 - Multiple memory modules in a large memory
 - Simultaneous communication in switched LAN
- HW and SW developers should innovate assuming Latency Lags Bandwidth
 - If everything improves at the same rate, then nothing really changes
 - When rates vary, require real innovation



Clock Rate and Power

- Intel 80386 consumed ~ 2 W
- 4.0 GHz Intel Core i7 consumes 95W
- Heat must be dissipated from 1.5 x 1.5 cm² chip
- This is the limit of what can be cooled by air





Define and Quantity Power and Energy

- Problem: Get power in, get power out
 - What is the maximum power a processor ever requires?
 - What is the sustained power consumption?
- Thermal Design Power (TDP)
 - Characterizes sustained power consumption
 - Used as target for power supply and cooling system
 - Lower than peak power, higher than average power consumption
- Power vs. Energy?
 - Clock rate can be reduced dynamically to limit power consumption
 - Energy per task is often a better measurement
 - Designers and users need to consider is energy and energy efficiency

Power and Energy (1/2)

 For CMOS chips, traditional dominant power consumption has been in switching transistors, called dynamic power

$$P_{dynamic} \propto \frac{1}{2} \times C_{load} \times V^2 \times F$$

- For mobile devices, dynamic energy, instead of power, is the proper metric
 - Transistor switch from 0 -> 1 or 1 -> 0

$$E_{dynamic} \propto C \times V^2$$

- For a fixed task, slowing clock rate (frequency switched) reduces power, but not energy
- Dropping voltage helps both, so went from 5V to 1V
- As moved from one process to the next, the increase in the number of transistors switching, the frequency, dominates the decrease in load capacitance and voltage
 - → an overall growth in power consumption and energy
- To save energy & dynamic power, most CPUs now turn off clock of inactive modules (e.g. Fl. Pt. Unit)



DVFS Power/Energy Saving Example

- Some microprocessors today are designed to have adjustable voltage.
 Assume a 15% reduction in voltage will result in a 15% reduction in frequency, what would be the impact on dynamic energy and dynamic power?
- Because the capacitance is unchanged, the answer for energy is

$$\frac{\text{Energy}_{\text{new}}}{\text{Energy}_{\text{old}}} = \frac{(Voltage \times 0.85)^2}{Voltage^2} = 0.72$$

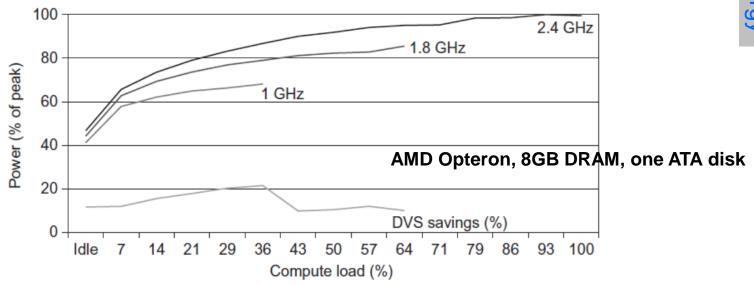
For power, the answer is

$$\frac{\text{Power}_{\text{new}}}{\text{Power}_{\text{old}}} = \frac{(Voltage \times 0.85)^2 \times (Frequency \times 0.85)}{Voltage^2 \times Frequency} = 0.61$$



Reducing Power

- Techniques for reducing power:
 - Do nothing well by clock gating
 - Dynamic Voltage-Frequency Scaling (DVFS)



- Design for the typical case. Low power state for DRAM, disks
- Overclocking one while turning off the other cores (Intel Turbo mode)

Power and Energy (2/2)

 Because leakage current flows even when a transistor is off, now static power is important too

$$P_{static} \propto I_{static} \times V$$

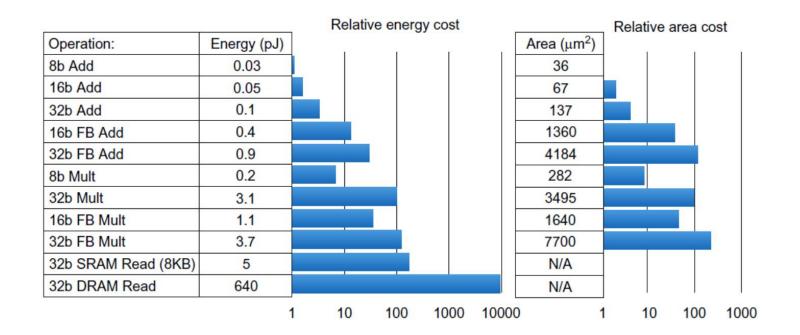
- Increasing the number of transistors increases power even if they are turned off
- Leakage current increases in processors with smaller transistor sizes
- 20-50% of total power is static
- Very low power systems even gate voltage to inactive modules (i.e. power gating) to control loss due to leakage



Comparison of Energy and Die Area

[ISSCC 2014]

- @ TSMC 45nm CMOS technology
- FP units are used by DesignWare Library
- New design directions? By reducing wide FP operations and deploying special-purpose memories to reduce access to DRAM.





Trends in Cost

- Price: what you sell a finished good for
- Cost: amount spent to produce it, including overhead
 - Price and cost of DRAM track closely.
- The impact of time, volume, and commodification
 - Learning curve: manufacturing costs decrease over time (max. measured by yield)
 - Volume decreases the cost
 - Costs decrease about 10% for each doubling of volumn
 - Commodities: sell on the grocery stores, multiple suppliers.

Cost of an IC

A wafer is tested and chopped into dies

$$C_{\text{die}} = \frac{C_{\text{wafer}}}{\text{Die per wafer} \times \text{Die yield}}$$

Die per wafer =
$$\frac{\pi \times (\text{Wafer diameter/2})^2}{\text{Die area}} - \frac{\pi \times \text{Wafer diameter}}{\sqrt{2} \times \sqrt{\text{Die area}}}$$

The die is still tested and packaged into IC

$$C_{\text{IC}} = \frac{C_{\text{die}} + C_{\text{testingdie}} + C_{\text{packagingand final test}}}{\text{Final test yield}}$$







IC Yield

Bose-Einstein formula:

Die yield = Wafer yield $\times 1/(1 + \text{Defects per unit area} \times \text{Die area})^N$

- Wafer yield is almost 100%
- Defects per unit area = 0.012-0.016 defects per cm² (28nm, 2017)
- Defects per unit area = 0.016-0.047 defects per cm² (16nm, 2017)
- N = process-complexity factor = 7.5—9.5.5 (28nm, 2017) and 10—14 (16nm, 2017)
- Example: Find the die yield for dies that are 1.5 cm on a side.
 Assuming a 300mm wafer and a defect density of 0.047/cm² and N is 12.

Dies per wafer =
$$\frac{\pi \times (30/2)^2}{2.25} - \frac{\pi \times 30}{\sqrt{2 \times 2.25}} = 270$$

Die yield =
$$1/(1+0.047\times2.25)^{12}\times270=120$$



Dependability?

- Old CW: ICs are reliable components
- New CW: On the transistor feature size down to 65nm or smaller, both transient faults and permanent faults will become more common place.
- Define and quantity dependability
 - 2 states of finite state machine: Failure and Restoration
 - Service accomplishment vs. Service interruption
- Module/system reliability
 - Mean time to failure (MTTF)
 - Mean time to repair (MTTR)
 - Mean time between failures (MTBF) = MTTF + MTTR
 - Availability = MTTF / MTBF



Define and Quantity Dependability

- Module reliability = measure of continuous service accomplishment (or time to failure).
 - 2 metrics
 - 1. Mean Time To Failure (MTTF) measures Reliability
 - 2. Failures In Time (FIT) = 1/MTTF, the rate of failures
 - Traditionally reported as failures per billion hours of operation
- Mean Time To Repair (MTTR) measures Service Interruption
 - Mean Time Between Failures (MTBF) = MTTF+MTTR
- Module availability = measure of the service accomplishment with respect to the alternation between the 2 states
- Module availability = MTTF / (MTTF + MTTR)



Dependability Example

- Assume a disk subsystem with the following components and MTTF:
 - 10 disks, each rated at 1000000-hour MTTF
 - 1 ATA controller, 500000-hour MTTF
 - 1 power supply, 200000-hour MTTF
 - 1 fan, 200000-hour MTTF
 - 1 ATA cable, 1000000-hour MTTF
- Suppose the lifetimes are exponentially distributed and failures are independent
- Answer:

Failure rate =
$$\frac{10}{1000000} + \frac{1}{500000} + \frac{1}{200000} + \frac{1}{200000} + \frac{1}{1000000}$$

$$MTTF = \frac{1}{FIT} = \frac{1000000 \text{ hours}}{23} \approx 43500 \text{ hours}$$



Measuring Performance

- Typical performance metrics:
 - Response time
 - Throughput
- Speedup of X relative to Y
 - Execution time_Y / Execution time_X
- Execution time
 - Wall clock time: includes all system overheads
 - CPU time: only computation time
- Benchmarks
 - Kernels (e.g. matrix multiply)
 - Toy programs (e.g. sorting)
 - Synthetic benchmarks (e.g. Dhrystone)
 - Benchmark suites (e.g. SPEC CPU 2017, TPC-C)

Performance Measurement

Two different machines X and Y.

X is *n* times faster than Y

$$\frac{\text{Execution time}_{Y}}{\text{Execution time}_{X}} = n$$

Since execution time is the reciprocal of performance

$$\frac{\text{Execution time}_{Y}}{\text{Execution time}_{X}} = n = \frac{\text{Performance}_{X}}{\text{Performance}_{Y}}$$

• Says n - 1 = m/100

This concludes that X is m% faster than Y

Performance Equation

CPU time = Instruction count \times Cycles per instruction \times Cycle time

$$= \frac{Instructions}{Program} \times \frac{Clock\ cycles}{Instruction} \times \frac{Seconds}{Clock\ cycle}$$
Seconds

It is difficult to change one parameter in complete isolation from others!!

- Instruction set architecture and compiler technology
- Organization and instruction set architecture
- Hardware technology and organization

Program

Aspects of CPU Performance (CPU Law)

CPU time	= Seconds	= Instructions x	Cycles x	Seconds		\
	Program	Program	Instruction	Cycle		
					Inst	Cycle

	Inst Count	CPI	Clock Rate
Program	X		
Compiler	X	(X)	
Inst. Set.	X	X	
Organization		X	X
Technology			X

Count

Time

CPI and **CPU** Time

Different instruction types having different CPIs

$$CPU clock cycles = \sum_{i=1}^{n} CPI_{i} \times IC_{i}$$

Throughput

CPI_i = average number of clock cycles for instruction-i

IC_i = number of time the instruction-i is executed in a program

CPU time =
$$(\sum_{i=1}^{n} CPI_i \times IC_i) \times clock$$
 cycle time

$$CPI = \frac{\sum_{i=1}^{n} CPI_{i} \times IC_{i}}{Instruction count} = \sum_{i=1}^{n} CPI_{i} \times \frac{IC_{i}}{Instruction count}$$

Example

We have the following measurements:

Freq. of FP operation (other than FPSQR) = 25%

Average CPI of FP operation = 4

Average CPI of other instructions = 1.33

Freq. of FPSQR = 2%

CPI of FPSQR = 20

Assume we have 2 design alternatives

- 1. CPI of FPSQR: $20 \rightarrow 2$, 10 times improve
- 2. CPI of FP operations: $4 \rightarrow 2.5$, 1.6 times improve

Answer: (Only CPI changes, clock rate, instruction count remains identical)

$$CPI_{original} = \sum_{i=1}^{n} CPI_{i} \times (IC_{i} / Instruction count) = 4 \times 0.25 + 1.33 \times 0.75 = 2.0$$

$$\begin{aligned} \text{CPI}_{\text{new FPSQR}} &= \text{CPI}_{\text{original}} - 2\% \; (\text{CPI}_{\text{old FPSQR}} - \text{CPI}_{\text{new FPSQR only}}) \\ &= 2.0 - 2\% \; (20 - 2) = 1.64 \end{aligned}$$

$$CPI_{newFP} = \sum_{i=1}^{n} CPI_{i} \times (IC_{i} / Instruction count) = 2.5 \times 0.25 + 1.33 \times 0.75 = 1.625$$
Better !!



Reporting Performance Results

- Which benchmark(s)?
- Performance Results should be reproducibility
 - Describe exactly the software system being measured and whether any special modifications have been made.
- Arithmetic average of execution time of all programs?
- Could add a weight per program?
 - How pick weight? Different company wants different weights for their product
- Normalized execution time with respect to a reference computer
 - Time on reference computer / time on computer being rated
 - SPECRatio

Compare/Summarize Performance

- WLOG, 2 different ways
 - 1. Arithmetic mean

$$\frac{1}{n}\sum_{i=1}^{n} \text{Time}_{i}$$

- Time; is the execution time for the ith program in the workload
- Weighted arithmetic mean

$$\sum_{i=1}^{n} Weight_{i} \times Time_{i}$$

- Weight_i factors add up to 1
- 2. Geometric mean

$$\sqrt[n]{\prod_{i=1}^{n} \text{Execution time ratio}_{i}}$$

- To normalize to a reference machine (e.g. SPEC)
- Execution time ratio_i is the execution time normalized to the reference machine, for the ith program



Ratio of SPECRatio

$$e.g. \ 1.25 = \frac{SPECRatio_{A}}{SPECRatio_{B}} = \frac{\frac{ExecutionTime_{reference}}{ExecutionTime_{A}}}{\frac{ExecutionTime_{reference}}{ExecutionTime_{B}}} = \frac{\frac{ExecutionTime_{A}}{ExecutionTime_{B}}}{\frac{ExecutionTime_{B}}{ExecutionTime_{A}}} = \frac{\frac{Performance_{A}}{Performance_{B}}}{\frac{Performance_{B}}{Performance_{B}}}$$

- SPECRatio is just a ratio rather than an absolute execution time
- Note that when comparing 2 computers as a ratio, execution times on the reference computer drop out, so choice of reference computer is irrelevant

Geometric mean of the ratios is the ratio of geometric means

Choice of reference computer is irrelevant.

$$\begin{split} \frac{Geometric\ Mean_{A}}{Geometric\ Mean_{B}} &= \sqrt[n]{\prod_{i=1}^{n} SPECRatioA_{i}} \\ &= \sqrt[n]{\prod_{i=1}^{n} SPECRatioB_{i}} \\ &= \sqrt[n]{\prod_{i=1}^{n} SPECRatioB_{i}} \\ &= \sqrt[n]{\prod_{i=1}^{n} \frac{ExecutionTimeB_{i}}{ExecutionTimeA_{i}}} \\ &= \sqrt[n]{\prod_{i=1}^{n} \frac{PerformanceA_{i}}{PerformanceB_{i}}} \end{split}$$

Geometric mean does not predict execution time

Principles of Computer Design

- 1. Take Advantage of Parallelism
 - e.g. multiple processors, disks, memory banks, pipelining, multiple functional units
- 2. Principle of Locality
 - Reuse of data and instructions
- Focus on the Common Case
 - Amdahl's Law

Execution time_{new} = Execution time_{old}
$$\times \left((1 - Fraction_{enhanced}) + \frac{Fraction_{enhanced}}{Speedup_{enhanced}} \right)$$



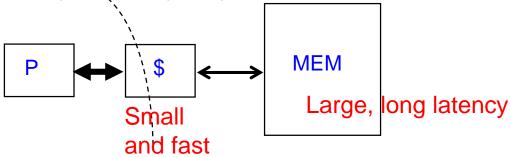
1) Taking Advantage of Parallelism

- Carry lookahead adders uses parallelism to speed up computing sums from linear to logarithmic in number of bits per operand
- Set-associative caches searches in parallel by using multiple memory banks searched
- Pipelining technique overlaps instruction execution to reduce the total time to complete an instruction sequence.
- ILP, DLP, TLP, ...
- Server computer increase throughput of via multiple processors or multiple tasks/disks



2) The Principle of Locality

- The Principle of Locality:
 - Program access a relatively small portion of the address space at any instant of time.
- Two Different Types of Locality:
 - <u>Temporal Locality</u> (Locality in Time): If an item is referenced, it will tend to be referenced again soon (e.g., loops, reuse)
 - Spatial Locality (Locality in Space): If an item is referenced, items whose addresses are close by tend to be referenced soon (e.g., straight-line code, array access)
- Cache in memory hierarchy for performance.





3) Focus on the Common Case

- Common sense guides computer design
 - Since its engineering, common sense is valuable
- In making a design trade-off, favor the frequent case over the infrequent case
 - E.g., Instruction fetch and decode unit used more frequently than multiplier, so optimize it 1st
 - E.g., If database server has 50 disks / processor, storage dependability dominates system dependability, so optimize it 1st
- Frequent case is often simpler and can be done faster than the infrequent case
 - E.g., overflow is rare when adding 2 numbers, so improve performance by optimizing more common case of no overflow
 - May slow down overflow, but overall performance improved by optimizing for the normal case
- What is frequent case and how much performance improved by making case faster => Amdahl's Law



Amdahl's Law

$$\begin{aligned} &\text{ExTime}_{\text{new}} = \text{ExTime}_{\text{old}} \times \left[(1 - \text{Fraction}_{\text{enhanced}}) + \frac{\text{Fraction}_{\text{enhanced}}}{\text{Speedup}_{\text{enhanced}}} \right] \\ &\text{Speedup}_{\text{overall}} = \frac{\text{ExTime}_{\text{old}}}{\text{ExTime}_{\text{new}}} = \frac{1}{(1 - \text{Fraction}_{\text{enhanced}}) + \frac{\text{Fraction}_{\text{enhanced}}}{\text{Speedup}_{\text{enhanced}}}} \end{aligned}$$

Best you could ever hope to do:

$$Speedup_{maximum} = \frac{1}{(1 - Fraction_{enhanced})}$$
old
new

Example

Two design alternative for FP square root

- 1. Add FPSQR hardware
 - 20% of the execution time in benchmark
 - → Speedup factor 10
- 2. Make all FP instructions faster

50% of the execution time for all FP instructions

→ 1.6 times faster

Answer

Speedup_{FPSQR} =
$$\frac{1}{(1-0.2) + \frac{0.2}{10}} = 1.22$$

Speedup_{FP} =
$$\frac{1}{(1-0.5) + \frac{0.5}{1.6}} = 1.23$$

→ Improving the performance of the FP operations overall is slightly better because of the higher frequency



SPEC Power Benchmark

- SPECpower uses a software stack written in Java which represents the server side of business applications.
- SPECpower measures the power consumption of server at different workload levels
 - Performance: ssj_ops/sec
 - Power: Watts (Joules/sec)

Overall ssj_ops per Watt =
$$\left(\sum_{i=0}^{N-1} ssj_ops_i\right) / \left(\sum_{i=0}^{N-1} power_i\right)$$

server side Java operations per second per watt



SPECpower_ssj2008 for Xeon X5650

Target Load %	Performance (ssj_ops)	Average Power (Watts)
100%	865,618	258
90%	786,688	242
80%	698,051	224
70%	607,826	204
60%	521,391	185
50%	436,757	170
40%	345,919	157
30%	262,071	146
20%	176,061	135
10%	86,784	121
0%	0	80
Overall Sum	4,787,166	1,922
Σ ssj_ops/ Σ power =		2,490



Fallacies and Pitfalls

Counterexamples

Mistakes

- Pitfall: All exponential laws must come to an end
 - Dennard scaling (power density was constant as transistors got smaller, 1974)
 - Chip could be designed to operate faster and still us less power.
 - Static power becomes a significant fraction of overall power.
 - Disk capacity
 - 30-100% per year to 5% per year
 - Moore's Law
 - Most visible with DRAM capacity
 - ITRS disbanded
 - Only four foundries left producing state-of-the-art logic chips (2017) and 11 nm, 3 nm might be the limit
- Fallacy: Microprocessors are a silver bullet
 - Performance is now a programmer's burden